



Product Change Notification

Change Notification #: 116194 - 00
Change Title: Select Intel® SSD DC P4510 Series,
PCN 116194-00, Product Design,
Firmware Update
Date of Publication: April 09, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 9, 2018
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Description of Change to the Customer:

The Intel® SSD DC P4510 Series firmware version is being updated from VDV10120 to VDV10131. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX010T801	959391	J65287-102	J65296-102	J65287-103	J65296-103
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX010T810	959392	J65288-102	J65296-102	J65288-103	J65296-103
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX020T801	959393	J65291-003	J65298-003	J65291-004	J65298-004
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX020T810	959394	J65292-003	J65298-003	J65292-004	J65298-004
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX040T801	959395	J65289-100	J65297-100	J65289-101	J65297-101
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX040T810	959396	J65290-100	J65297-100	J65290-101	J65297-101
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX080T801	959397	J65293-001	J65299-001	J65293-002	J65299-002
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX080T810	959398	J65294-001	J65299-001	J65294-002	J65299-002

PCN Revision History:

Date of Revision:

April 9, 2018

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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